



GWM17S60Y

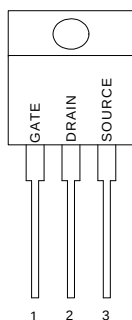
POWER FIELD EFFECT TRANSISTOR

GENERAL DESCRIPTION

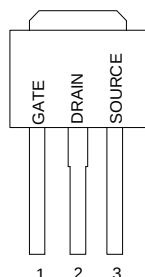
This advanced high voltage MOSFET is designed to withstand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode with fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

PIN CONFIGURATION

TO-220/TO-220FP
Top View



TO-251
Front View



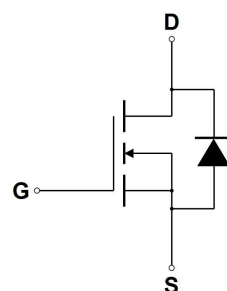
TO-252
Front View



FEATURES

- ◆ SJ MOS
- ◆ Higher Current Rating
- ◆ Lower $R_{ds(on)}$
- ◆ Lower Capacitances
- ◆ Lower Total Gate Charge

SYMBOL



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain to Current — Continuous	$I_{D(1)}$	17	A
— Pulsed	I_{DM}	51	
Gate-to-Source Voltage — Continue	V_{GS}	± 20	V
Total Power Dissipation TO-220	P_D	164.4	W
TO-220FP		56.8	
TO-251/TO-252		81.2	
Derate above 25°C TO-220		1.31	W/°C
TO-220FP		0.45	
TO-251/TO-252		0.65	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C
Single Pulse Drain-to-Source Avalanche Energy — $T_J = 25^\circ\text{C}$ ($V_{DD} = 100\text{V}$, $V_{GS} = 10\text{V}$, $I_L = 6.3\text{A}$, $L = 10\text{mH}$)	E_{AS}	198.5	mJ
Thermal Resistance — Junction to Case TO-220	θ_{JC}	0.76	°C/W
TO-220FP		2.2	
TO-251/TO-252		1.54	
— Junction to Ambient TO-251/TO-252/ TO-220/ TO-220FP	θ_{JA}	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	260	°C

(1) Drain current limited by maximum junction temperature (TO-220)



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POWER FIELD EFFECT TRANSISTOR

ORDERING INFORMATION

Part Number	TOP MARK	Part Number	Packing Mthod	Note
GWM17S60YWXN251 (Note1)	GWM17S60Y	TO-251	Tube	
GWM17S60YWXN252 (Note1)	GWM17S60Y	TO-252	Tube	
GWM17S60YWXN252TR (Note1)	GWM17S60Y	TO-252	Tape and Reel	
GWM17S60YWXN220 (Note1)	GWM17S60Y	TO-220	Tube	
GWM17S60YWXN220FP (Note1)	GWM17S60Y	TO-220FP	Tube	

Note1: X : Suffix for Halogen Free and PB Free Product

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $T_J = 25^{\circ}\text{C}$

		GWM17S60Y				
Characteristic		Symbol	Min	Typ	Max	Units
Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250μA)		V _{(BR)DSS}	600			V
Drain-Source Leakage Current (V _{DS} = 600V, V _{GS} = 0V)		I _{DSS}			1	uA
Gate-Source Leakage Current-Forward (V _{gsf} = 20V, V _{DS} = 0V)		I _{GSSF}			100	nA
Gate-Source Leakage Current-Reverse (V _{gsr} = - 20V, V _{DS} = 0V)		I _{GSSR}			100	nA
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 250μA)		V _{GS(th)}	2		4	V
Static Drain-Source On-Resistance (V _{GS} = 10V, I _D = 5.7A)*		R _{DS(on)}			280	mΩ
Input Capacitance	(V _{DS} = 100V, V _{GS} = 0V, f = 1.0MHz)	C _{iss}		750		pF
Output Capacitance		C _{oss}		41		pF
Reverse Transfer Capacitance		C _{rss}		1		pF
Turn-On Delay Time	(V _{DD} = 300V, I _D = 17A, V _{GS} = 10 V,R _G = 9.1Ω)*	t _{d(on)}		14		ns
Rise Time		t _r		40		ns
Turn-Off Delay Time		t _{d(off)}		33		ns
Fall Time		t _f		23		ns
Total Gate Charge	(V _{DS} = 480V, I _D = 17A, V _{GS} = 10 V)*	Q _g		21		nC
Gate-Source Charge		Q _{gs}		6		nC
Gate-Drain Charge		Q _{gd}		10		nC
SOURCE-DRAIN DIODE CHARACTERISTICS						
Forward On-Voltage(1)	(I _S = 17A, dI _S /dI _t = 100A/μs)	V _{SD}			1.5	V
Forward Turn-On Time		t _{on}		**		ns
Reverse Recovery Time		t _{rr}		295		ns

* Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

** Negligible, Dominated by circuit inductance



TYPICAL ELECTRICAL CHARACTERISTICS

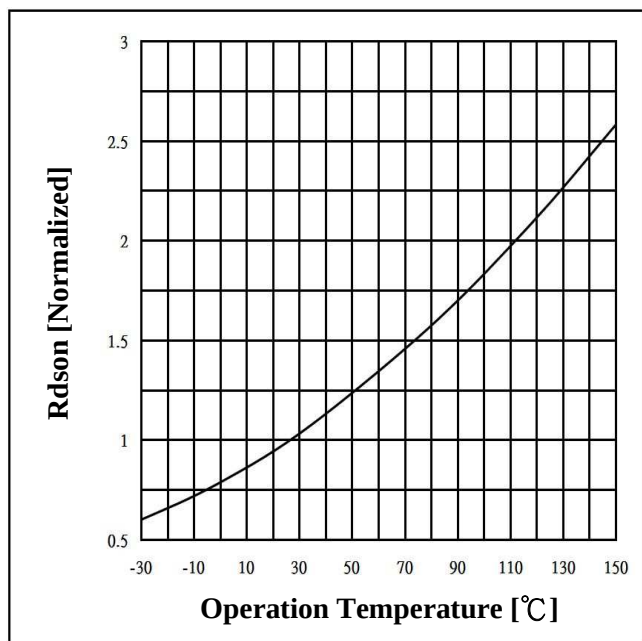


Fig 1. On-Resistance Variation with vs. Temperature

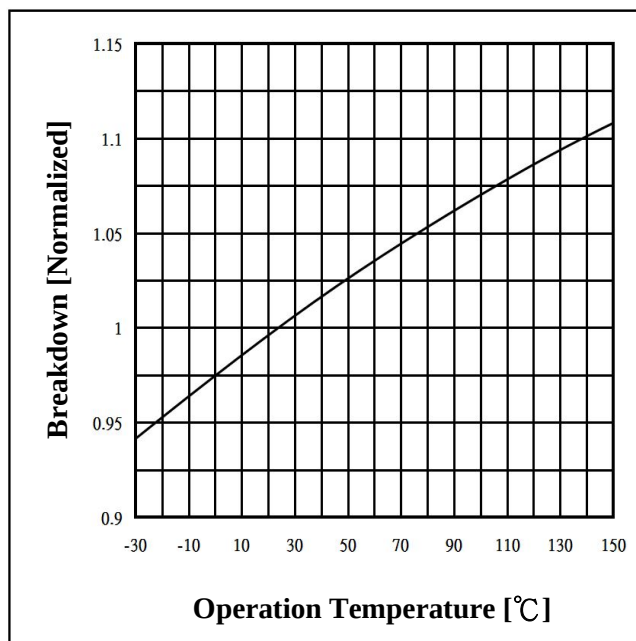


Fig.2 Breakdown Voltage Variation vs. Temperature

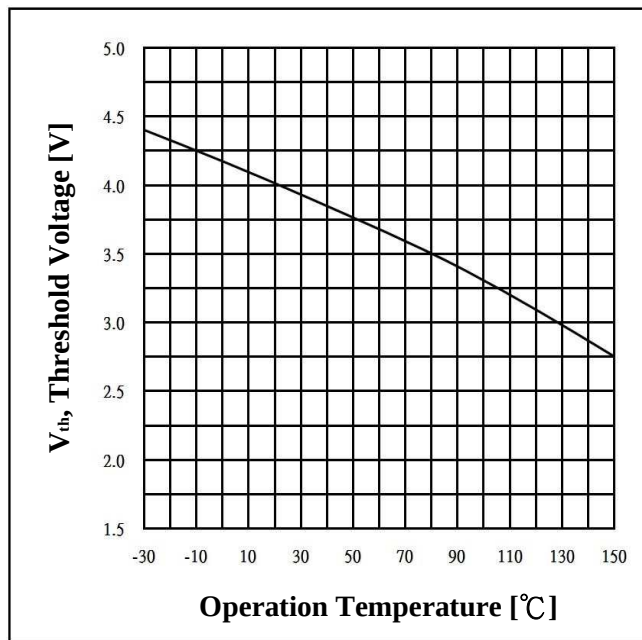


Fig 3. Threshold Voltage vs. Temperature

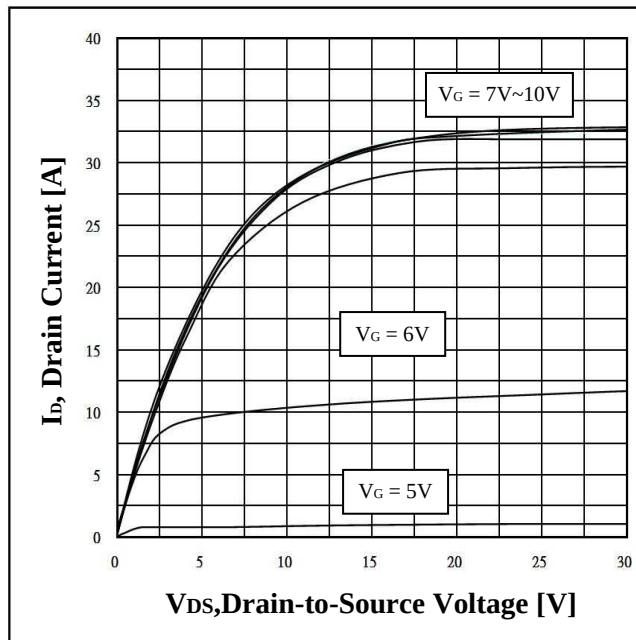


Fig 4. Typical Output Characteristics

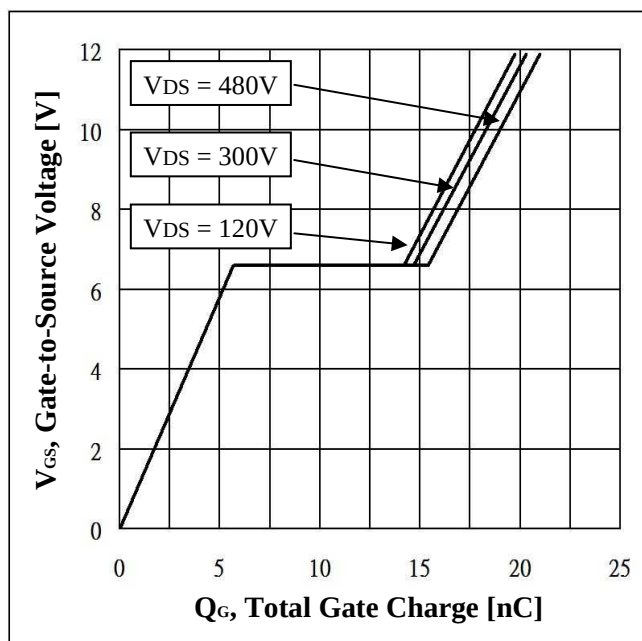


Fig 5. Typical Gate Charge Vs. Gate-to-Source Voltage

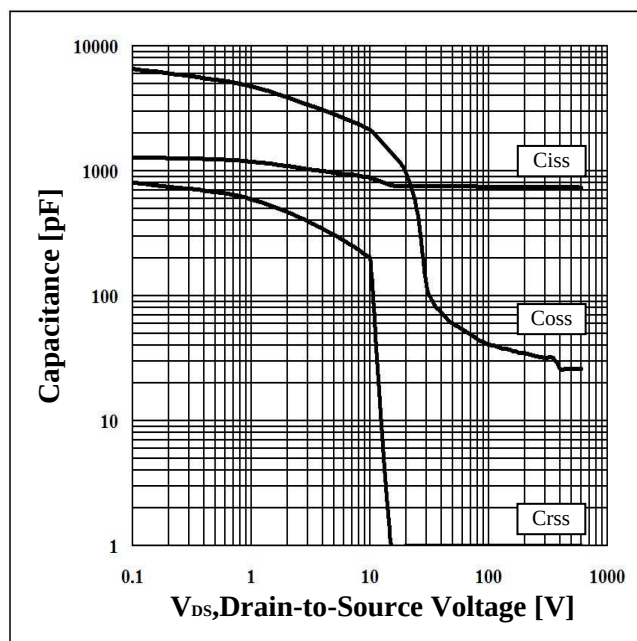


Fig 6. Typical Capacitance Vs. Drain-to-Source Voltage

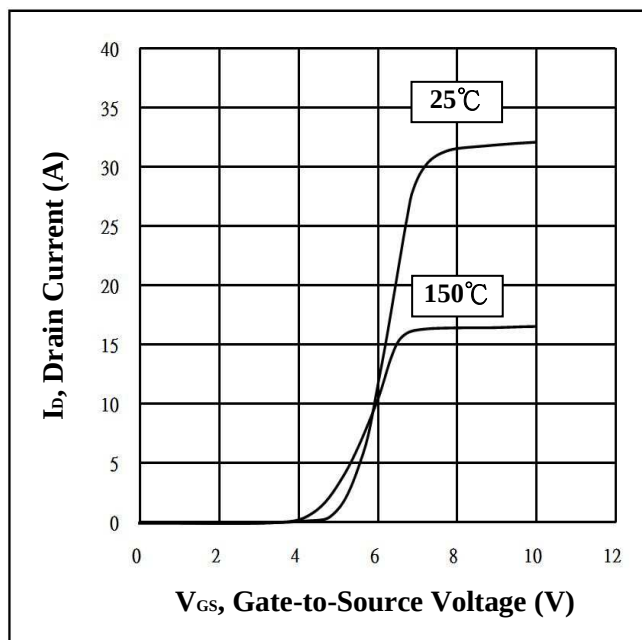


Fig 7. Typical Transfer Characteristics